

1. Product Features

1.1 Electrical features

- $V_{CES}=1200V$
- $I_{C\ nom}=50A / I_{CRM}=100A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- Integrated NTC temperature sensor
- High power and thermal cycling capability

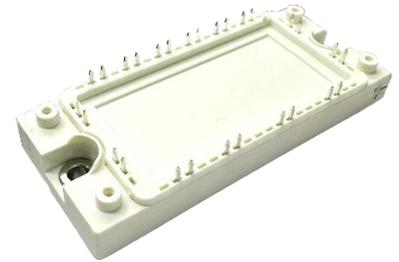


Figure 1 IGBT Module

1.2 Mechanical features

- Al_2O_3 substrate with low thermal resistance
- Copper base plate

2. Typical Applications

- Auxiliary inverters
- Motor drives
- Servo drives

3. Description

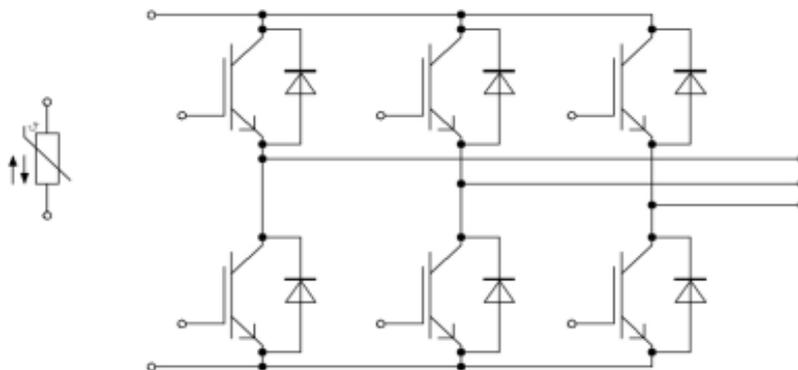


Figure 2 Half Bridge

4. IGBT, Inverter

4.1 Maximum rated values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V _{CEs}	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj} \text{ max} = 150^{\circ}\text{C}$	I _{C nom}	50	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1 \text{ ms}$	I _{CRM}	100	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj} \text{ max} = 175^{\circ}\text{C}$	P _{tot}	300	W
Gate-emitter peak voltage 栅极—发射极峰值电压		V _{GES}	+/- 20	V

4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 50 \text{ A}, V_{GE} = 15 \text{ V}$	V _{CE,sat}	1.5	$T_{vj} = 25^{\circ}\text{C}$	1.7	1.9	V
				$T_{vj} = 125^{\circ}\text{C}$	2.0		V
				$T_{vj} = 150^{\circ}\text{C}$	2.1		V
Gate threshold voltage 栅极阈值电压	$I_C = 1 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	V _{GE,th}	5.0	5.6	6.5	V	
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I _{CES}			1	mA	
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I _{GES}			100	nA	
Turn-on delay time, inductive load 开通延迟时间	$I_C = 50 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G,on} = 15 \Omega$	t _{d,on}		$T_{vj} = 25^{\circ}\text{C}$	0.13		us
				$T_{vj} = 125^{\circ}\text{C}$	0.14		us
				$T_{vj} = 150^{\circ}\text{C}$	0.14		us
Rise time, inductive load 上升时间	$I_C = 50 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G,on} = 15 \Omega$	t _r		$T_{vj} = 25^{\circ}\text{C}$	0.06		us
				$T_{vj} = 125^{\circ}\text{C}$	0.07		us
				$T_{vj} = 150^{\circ}\text{C}$	0.07		us

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time, inductive load 关断延迟时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 15\Omega$	$T_{vj} = 25^\circ C$		0.24		us
		$T_{vj} = 125^\circ C$		0.27		us
		$T_{vj} = 150^\circ C$		0.28		us
Fall time, inductive load 下降时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 15\Omega$	$T_{vj} = 25^\circ C$		0.28		us
		$T_{vj} = 125^\circ C$		0.46		us
		$T_{vj} = 150^\circ C$		0.48		us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 50A, V_{CE} = 600V, L_s=35nH$ $V_{GE} = +15/-15V, di/dt = 580A/\mu s$ $R_{G,on} = 15\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$		6.83		mJ
		$T_{vj} = 125^\circ C$		9.00		mJ
		$T_{vj} = 150^\circ C$		9.78		mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 50A, V_{CE} = 600V, L_s=35nH$ $V_{GE} = +15/-15V, dv/dt = 4700A/\mu s$ $R_{G,off} = 15\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$		3.37		mJ
		$T_{vj} = 125^\circ C$		4.86		mJ
		$T_{vj} = 150^\circ C$		5.28		mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 600V, t_p \leq 8 \mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$	I_{sc}		340		A
Thermal resistance, junction to case 结-外壳热阻	Per IGBT	$R_{th,Jc}$			0.5	K/W

5. Diode, Inverter

5.1 Maximum rated values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1200	V
Continuous DC forward current 连续正向直流电流		I_F	50	A
Repetitive peak forward current 正向重复峰值电流	$t_p = 1 ms$	I_{FRM}	100	A

5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 50 A, V_{GE} = 0 V$	$T_{vj} = 25^\circ C$		1.79		V
		$T_{vj} = 125^\circ C$		1.80		V
		$T_{vj} = 150^\circ C$		1.74		V

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	$I_F = 50A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 480 A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	I_{RM}		59	A
					68	A
					71	A
Recovered charge 恢复电荷	$I_F = 50A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 480 A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	Q_r		3.6	μC
					6.3	μC
					7.4	μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 50A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 480 A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	E_{rec}		0.5	mJ
					1.2	mJ
					1.6	mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode	$R_{th,Jc}$			0.54	K/W

6. NTC-Thermistor

6.1 Characteristic value

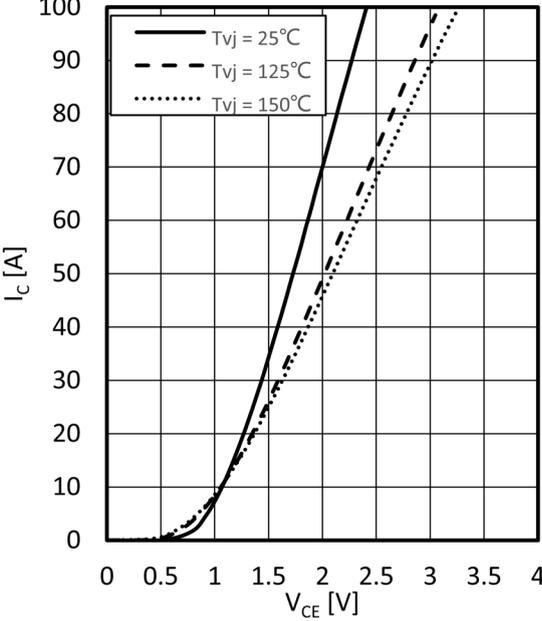
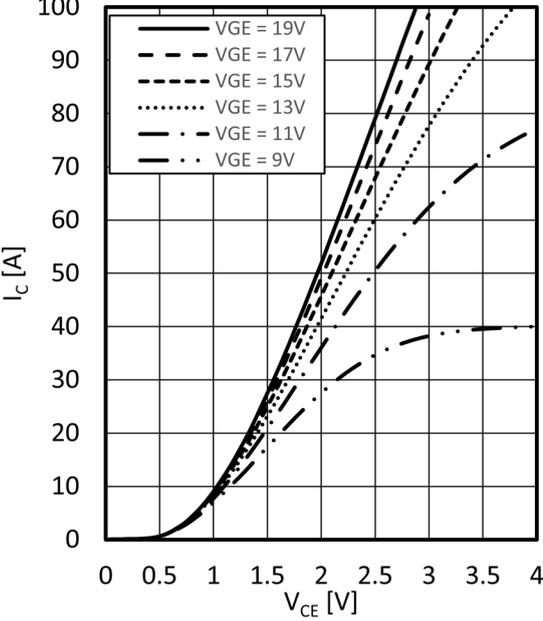
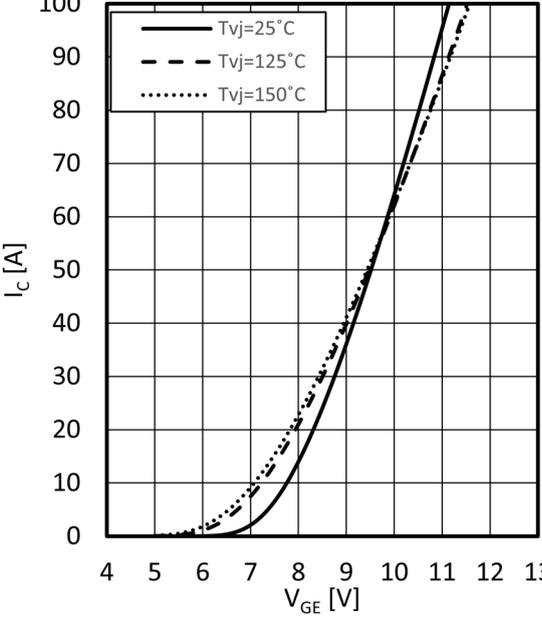
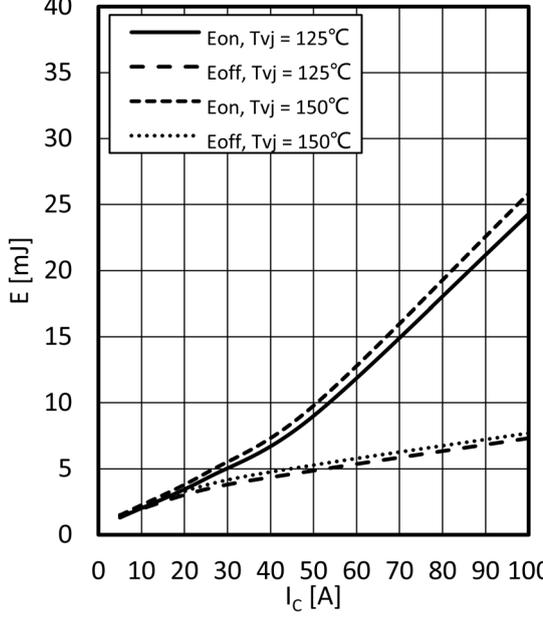
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance 额定电阻值	$T_c = 25^\circ C$	R_{25}		5.00		K Ω
Power dissipation 耗散功耗	$T_c = 25^\circ C$	P_{25}			20	mW
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298, 15K))]$	B_{25}/B_{50}		3400		K
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/75}(1/T_2-1/(298, 15K))]$	B_{25}/B_{75}		3430		K
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298, 15K))]$	B_{25}/B_{100}		3445		K

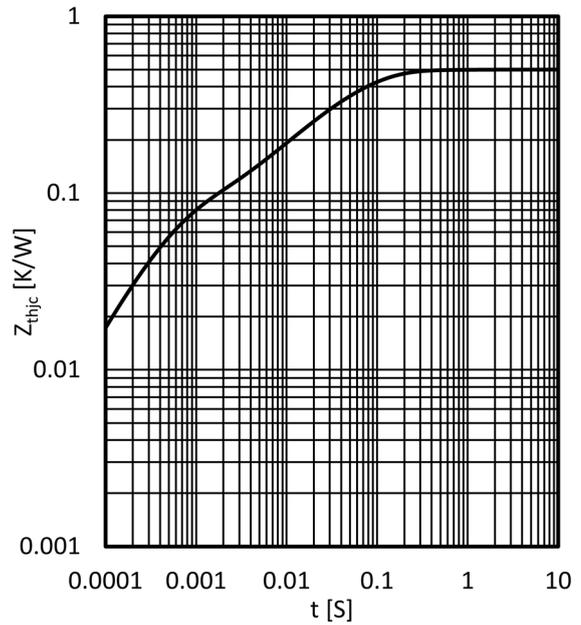
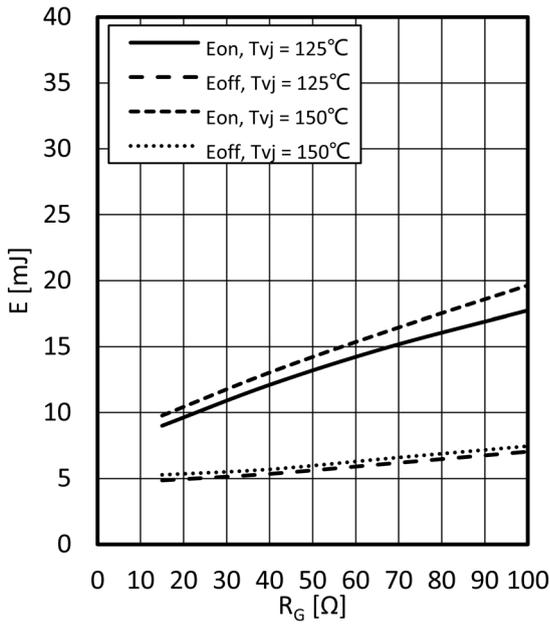
7. Module

7.1 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, f=50HZ,1min	V_{ISOL}			2500	V
Stray inductance module 杂散电感		L_{SCE}		20		nH
Operation Junction Temperature 结温		T_{jop}	-40		150	°C
Storage Temperature Range 存储温度范围		T_{stg}	-40		125	°C
Mounting Torque 安装扭矩	Screw M5	M	3		6	N.m
Weight of Module 重量		G		350		g

8. Characteristics diagrams

	
<p>Output characteristic IGBT, Inverter (typical) $I_c = f(V_{CE})$ $V_{GE} = 15V$</p>	<p>Output characteristic IGBT, Inverter (typical) $I_c = f(V_{CE})$ $T_{vj} = 150^\circ C$</p>
	
<p>Transfer characteristic IGBT, Inverter (typical) $I_c = f(V_{GE})$ $V_{CE} = 20V$</p>	<p>Switching losses IGBT, Inverter (typical) $E_{on} = f(I_c), E_{off} = f(I_c)$ $R_{Goff} = 15 \Omega, R_{Gon} = 15 \Omega, V_{CE} = 600V, V_{GE} = \pm 15V$</p>

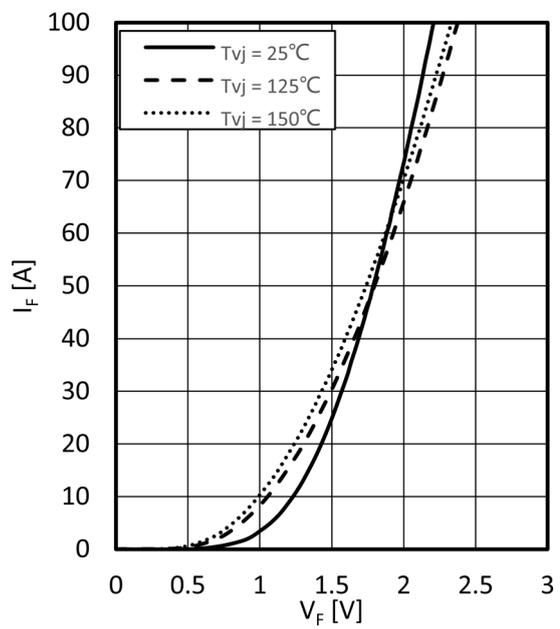
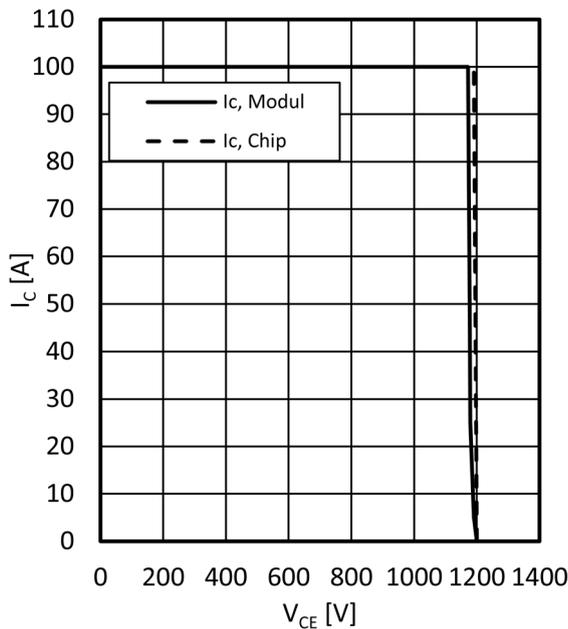


Switching losses IGBT, Inverter (typical)

$E_{on} = f(R_G), E_{off} = f(R_G)$
 $I_C = 50 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$

Transient thermal impedance IGBT, Inverter

$Z_{thjC} = f(t)$

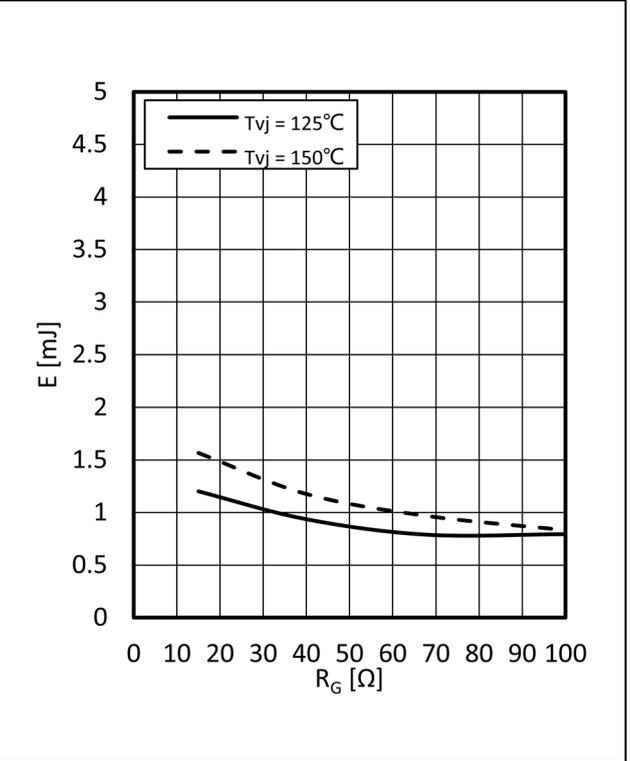
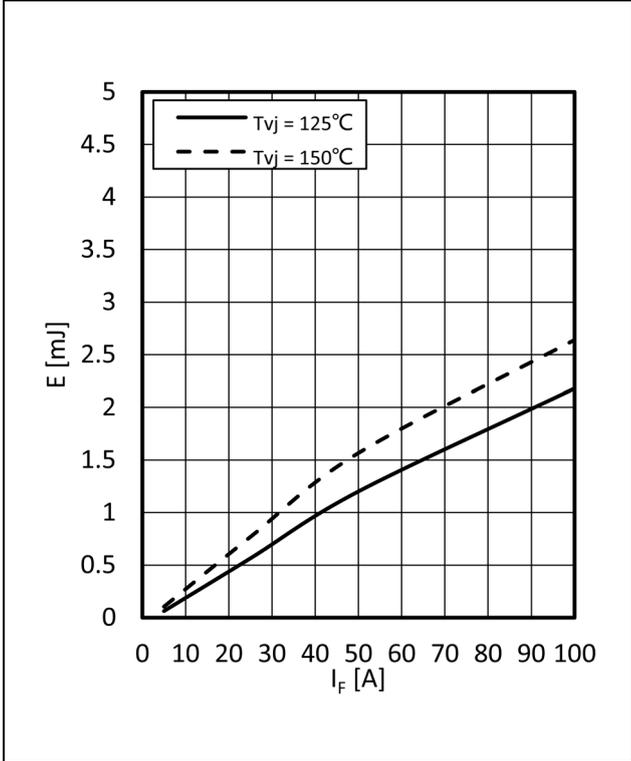


Reverse bias safe operating area IGBT, Inverter (RBSOA)

$I_C = f(V_{CE})$
 $V_{GE} = 15 \text{ V}, R_{Goff} = 15 \Omega, T_{vj} = 150 \text{ °C}$

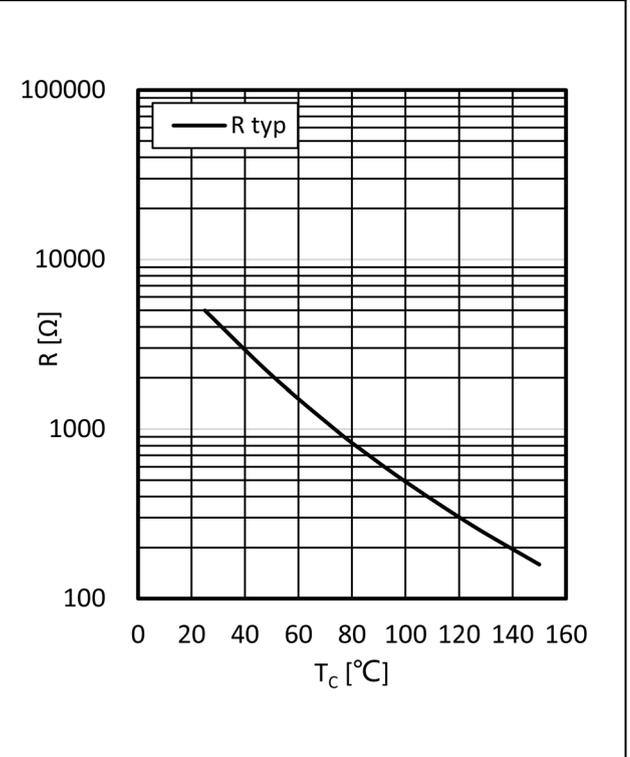
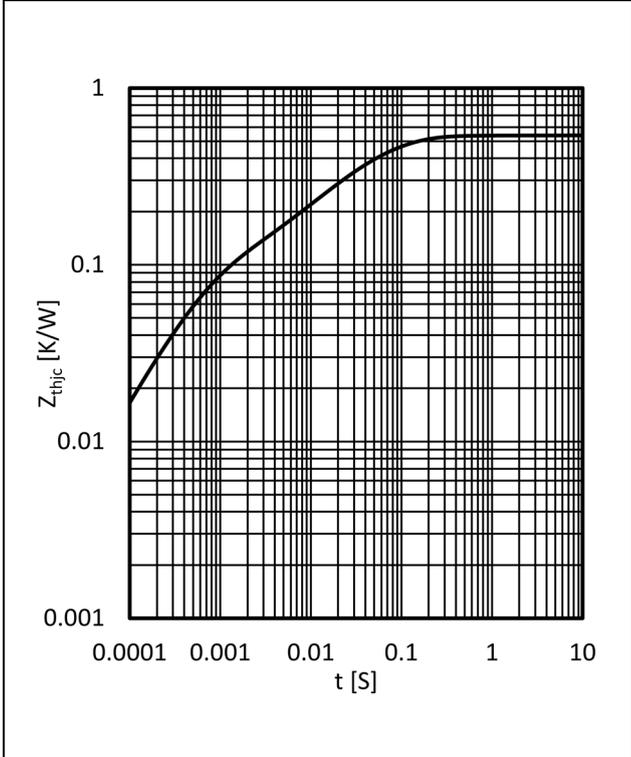
Forward characteristic of Diode, Inverter (typical)

$I_F = f(V_F)$



Switching losses Diode, Inverter (typical)
 $E_{rec} = f(I_F)$
 $R_{Gon} = 15 \Omega, V_{CE} = 600 V$

Switching losses Diode, Inverter (typical)
 $E_{rec} = f(R_G)$
 $I_F = 50 A, V_{CE} = 600 V$



Transient thermal impedance Diode, Inverter
 $Z_{thjC} = f(t)$

NTC-Thermistor-temperature characteristic (typical)
 $R = f(T_{NTC})$

9. Circuit Diagram

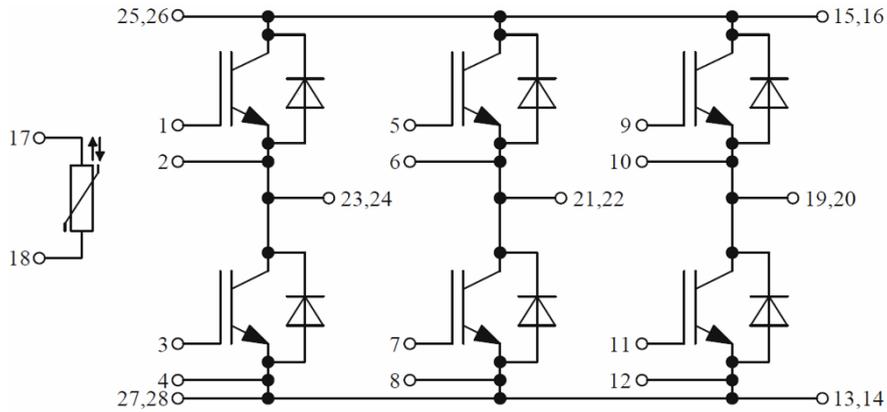


Figure 3

10. Package Outlines

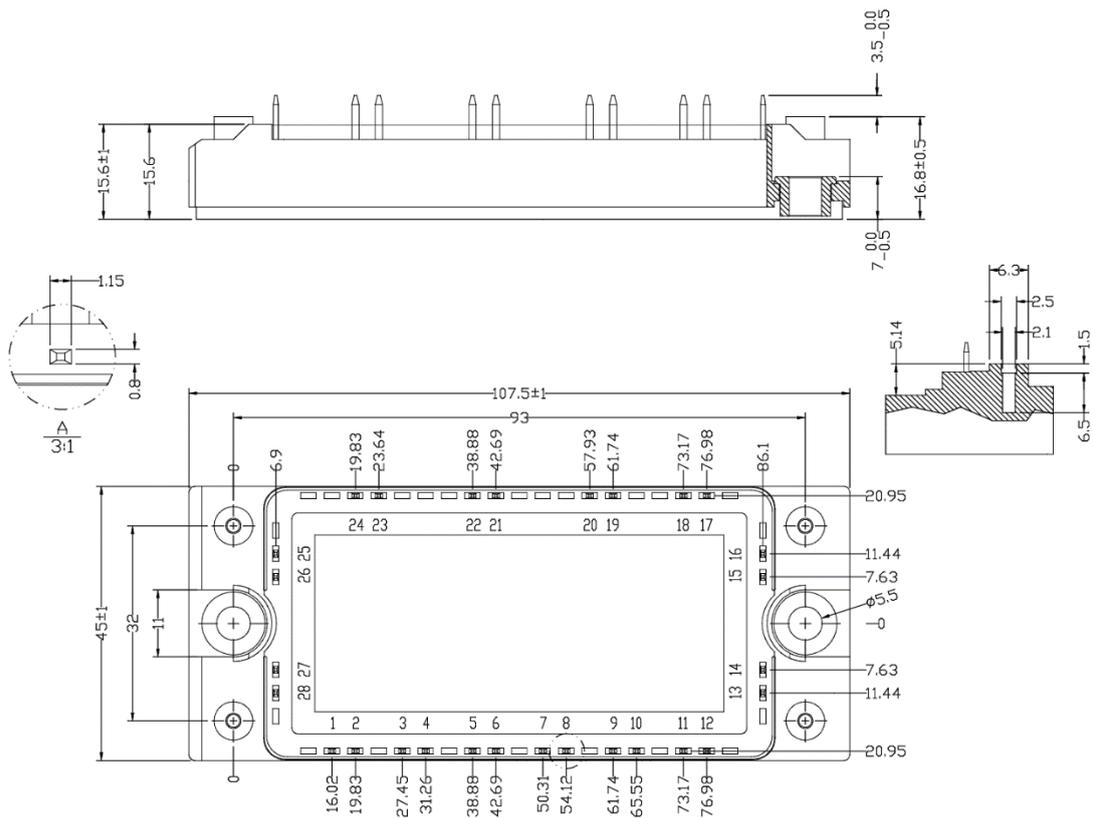


Figure 4